Triple low-ohmic single-pole double-throw analog switchRev. 5 — 25 June 2012Product data sheet

1. General description

The NX3L4053 is a triple low-ohmic single-pole double-throw analog switch, suitable for use as an analog or digital multiplexer/demultiplexer. Each switch has a digital select input (nS), two independent inputs/outputs (nY0 and nY1) and a common input/output (nZ). All three switches share an enable input (\overline{E}). A digital enable pin \overline{E} is common to all switches.When \overline{E} is HIGH, the switches are turned off.

Schmitt trigger action at the digital inputs makes the circuit tolerant to slower input rise and fall times. Low threshold digital inputs allows this device to be driven by 1.8 V logic levels in 3.3 V applications without significant increase in supply current I_{CC}. This makes it possible for the NX3L4053 to switch 4.3 V signals with a 1.8 V digital controller, eliminating the need for logic level translation. The NX3L4053 allows signals with amplitude up to V_{CC} to be transmitted from nZ to nY0 or nY1; or from nY0 or nY1 to nZ. Its low ON resistance (0.5 Ω) and flatness (0.13 Ω) ensures minimal attenuation and distortion of transmitted signals.

2. Features and benefits

- Wide supply voltage range from 1.4 V to 4.3 V
- Very low ON resistance (peak):
 - 1.8 Ω (typical) at V_{CC} = 1.4 V
 - 1.0 Ω (typical) at V_{CC} = 1.65 V
 - 0.6 Ω (typical) at V_{CC} = 2.3 V
 - 0.6 Ω (typical) at V_{CC} = 2.7 V
 - 0.5 Ω (typical) at V_{CC} = 4.3 V
- Break-before-make switching
- High noise immunity
- ESD protection:
 - HBM JESD22-A114F Class 3A exceeds 4000 V
 - MM JESD22-A115-A exceeds 200 V
 - CDM AEC-Q100-011 revision B exceeds 1000 V
 - ◆ IEC61000-4-2 contact discharge exceeds 6000 V for switch ports
- CMOS low-power consumption
- Latch-up performance exceeds 100 mA per JESD 78 Class II Level A
- 1.8 V control logic at V_{CC} = 3.6 V
- Control input accepts voltages above supply voltage
- Very low supply current, even when input is below V_{CC}
- High current handling capability (350 mA continuous current under 3.3 V supply)
- Specified from –40 °C to +85 °C and from –40 °C to +125 °C



Triple low-ohmic single-pole double-throw analog switch

3. Applications

- Cell phone
- PDA
- Portable media player
- Analog multiplexing and demultiplexing
- Digital multiplexing and demultiplexing
- Signal gating

4. Ordering information

 Table 1.
 Ordering information

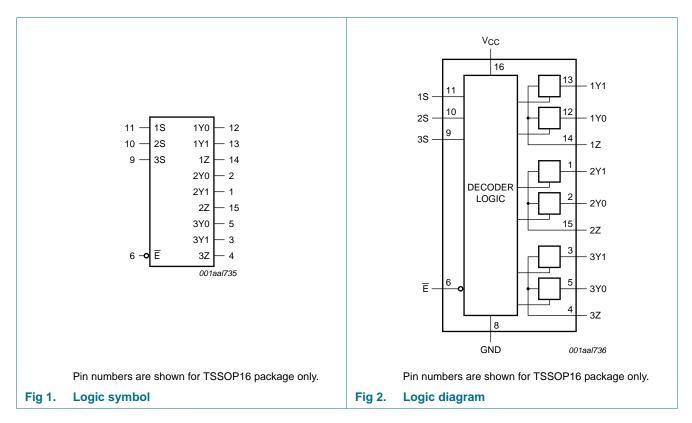
Type number	Package	Package									
	Temperature range	Name	Description	Version							
NX3L4053HR	–40 °C to +125 °C	HXQFN16	plastic thermal enhanced extremely thin quad flat package; no leads; 16 terminals; body $3 \times 3 \times 0.5$ mm	SOT1039-2							
NX3L4053PW	–40 °C to +125 °C	TSSOP16	plastic thin shrink small outline package; 16 leads; body width 4.4 mm	SOT403-1							

5. Marking

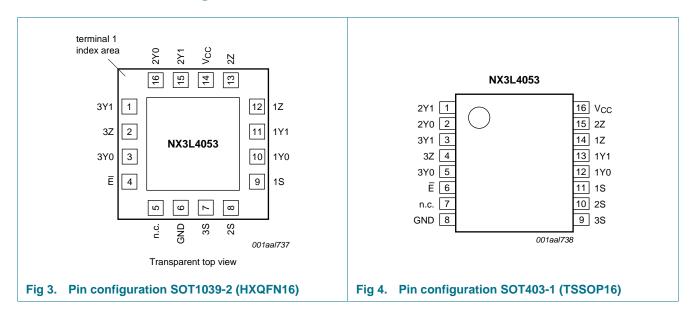
Table 2. Marking codes	
Type number	Marking code
NX3L4053HR	M43
NX3L4053PW	X3L4053

Triple low-ohmic single-pole double-throw analog switch

6. Functional diagram



7. Pinning information



7.1 Pinning

Triple low-ohmic single-pole double-throw analog switch

7.2 Pin description

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Symbol	Pin		Description
	SOT1039-2	SOT403-1	
Ē	4	6	enable input (active LOW)
n.c.	5	7	not connected
GND	6	8	ground (0 V)
1S, 2S, 3S	9, 8, 7	11, 10 ,9	select input
1Y0, 2Y0, 3Y0	10, 16, 3	12, 2, 5	independent input or output
1Y1, 2Y1, 3Y1	11, 15, 1	13, 1, 3	independent input or output
1Z , 2Z, 3Z	12, 13, 2	14, 15, 4	independent output or input
V _{CC}	14	16	supply voltage

8. Functional description

Table 4.	Function table		
Inputs		Channel on	
E		nS	-
L		L	nY0 to nZ
L		Н	nY1 to nZ
Н		Х	switches off

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care.

9. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+4.6	V
VI	input voltage	nS and E	<u>[1]</u> –0.5	+4.6	V
V _{SW}	switch voltage		2 -0.5	V _{CC} + 0.5	V
I _{IK}	input clamping current	$V_{I} < -0.5 V$	-50	-	mA
I _{SK}	switch clamping current	$V_{\rm I}$ < -0.5 V or $V_{\rm I}$ > $V_{\rm CC}$ + 0.5 V	-	±50	mA
I _{SW}	switch current	V_{SW} > -0.5 V or V_{SW} < V_{CC} + 0.5 V; source or sink current	-	±350	mA
		V_{SW} > -0.5 V or V_{SW} < V_{CC} + 0.5 V; pulsed at 1 ms duration, < 10 % duty cycle; peak current	-	±500	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 \text{ °C to } +125 \text{ °C}$			
		HXQFN16	[3]	250	mW
		TSSOP16	<u>[4]</u> _	500	mW

[1] The minimum input voltage rating may be exceeded if the input current rating is observed.

NX3L4053

Triple low-ohmic single-pole double-throw analog switch

- [2] The minimum and maximum switch voltage ratings may be exceeded if the switch clamping current rating is observed but may not exceed 4.6 V.
- [3] For HXQFN16 package: above 135 °C the value of Ptot derates linearly with 16.9 mW/K.
- [4] For TSSOP16 package: above 60 °C the value of P_{tot} derates linearly with 5.5 mW/K.

10. Recommended operating conditions

Table 6. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		1.4	4.3	V
VI	input voltage	nS and \overline{E}	0	4.3	V
V _{SW}	switch voltage		<u>[1]</u> 0	V _{CC}	V
T _{amb}	ambient temperature		-40	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	nS and \overline{E} ; V _{CC} = 1.4 V to 4.3 V	-	200	ns/V

[1] To avoid sinking GND current from terminal nZ when switch current flows in terminal nYn, the voltage drop across the bidirectional switch must not exceed 0.4 V. If the switch current flows into terminal nZ, no GND current will flow from terminal nYn. In this case, there is no limit for the voltage drop across the switch.

11. Static characteristics

Table 7.Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground 0 V).

Symbol	Parameter	Conditions	Ta	_{mb} = 25	°C	T _{amb} =	–40 °C to	+125 °C	Unit
			Min	Тур	Max	Min	Max (85 °C)	Max (125 °C)	
V _{IH}	/ _{IH} HIGH-level input voltage	V_{CC} = 1.4 V to 1.6 V	0.9	-	-	0.9	-	-	V
		V_{CC} = 1.65 V to 1.95 V	0.9	-	-	0.9	-	-	V
		V_{CC} = 2.3 V to 2.7 V	1.1	-	-	1.1	-	-	V
		V_{CC} = 2.7 V to 3.6 V	1.3	-	-	1.3	-	-	V
		V_{CC} = 3.6 V to 4.3 V	1.4	-	-	1.4	-	-	V
VIL	LOW-level	V_{CC} = 1.4 V to 1.6 V	-	-	0.3	-	0.3	0.3	V
	input voltage	V_{CC} = 1.65 V to 1.95 V	-	-	0.4	-	0.4	0.3	V
		V_{CC} = 2.3 V to 2.7 V	-	-	0.4	-	0.4	0.4	V
		V_{CC} = 2.7 V to 3.6 V	-	-	0.5	-	0.5	0.5	V
		V_{CC} = 3.6 V to 4.3 V	-	-	0.6	-	0.6	0.6	V
I	input leakage current	nS and \overline{E} ; V _I = GND to 4.3 V; V _{CC} = 1.4 V to 4.3 V	-	-	-	-	±0.5	±1	μΑ
I _{S(OFF)}	OFF-state leakage	nY0 and nY1 port; see <mark>Figure 5</mark>							
	current	V_{CC} = 1.4 V to 3.6 V	-	-	±5	-	±50	±500	nA
		$V_{CC} = 3.6 \text{ V} \text{ to } 4.3 \text{ V}$	-	-	±10	-	±50	±500	nA

NX3L4053

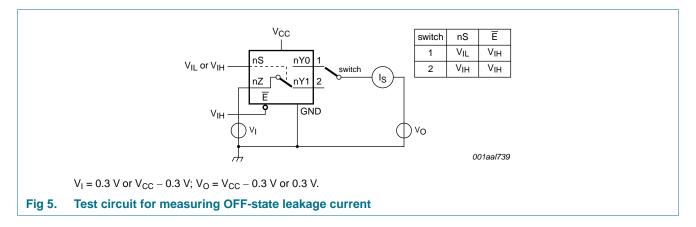
Triple low-ohmic single-pole double-throw analog switch

Table 7. Static characteristics ...continued

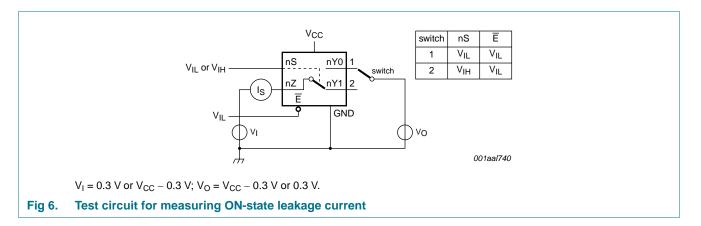
At recommended operating conditions; voltages are referenced to GND (ground 0 V).

Symbol	Parameter	Conditions	Τ _έ	amb = 25	°C	T _{amb} =	–40 °C to	+125 °C	Unit
			Min	Тур	Мах	Min	Max (85 °C)	Max (125 °C)	
leakag	ON-state leakage current	nZ port; $V_{CC} = 1.4 \text{ V to } 3.6 \text{ V};$ see Figure 6							
		$V_{CC} = 1.4 \text{ V to } 3.6 \text{ V}$	-	-	±5	-	±50	±500	nA
		$V_{CC} = 3.6 V \text{ to } 4.3 V$	-	-	±10	-	±50	±500	nA
I _{CC} supply current	$V_{I} = V_{CC} \text{ or GND};$ $V_{SW} = GND \text{ or } V_{CC}$								
		V _{CC} = 3.6 V	-	-	100	-	500	5000	nA
		$V_{CC} = 4.3 V$	-	-	150	-	800	6000	nA
ΔI_{CC}	additional	V_{SW} = GND or V_{CC}							
	supply current	$V_{I} = 2.6 \text{ V}; V_{CC} = 4.3 \text{ V}$	-	2.0	4.0	-	7	7	μA
		$V_{I} = 2.6 \text{ V}; V_{CC} = 3.6 \text{ V}$	-	0.35	0.7	-	1	1	μA
		$V_{I} = 1.8 \text{ V}; V_{CC} = 4.3 \text{ V}$	-	7.0	10.0	-	15	15	μA
		$V_{I} = 1.8 \text{ V}; V_{CC} = 3.6 \text{ V}$	-	2.5	4.0	-	5	5	μA
		$V_{I} = 1.8 \text{ V}; V_{CC} = 2.5 \text{ V}$	-	50	200	-	300	500	nA
CI	input capacitance	nS and \overline{E}	-	1.0	-	-	-	-	pF
$C_{S(OFF)}$	OFF-state capacitance		-	35	-	-	-	-	pF
$C_{S(ON)}$	ON-state capacitance		-	130	-	-	-	-	pF

11.1 Test circuits



Triple low-ohmic single-pole double-throw analog switch



11.2 ON resistance

Table 8. ON resistance^[1]

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for graphs see Figure 8 to Figure 14.

Symbol	Parameter	Conditions	T _{amb} =	-40 °C to	o +85 °C	$T_{amb} = -40 \circ$	C to +125 °C	Unit
			Min	Typ ^[2]	Max	Min	Max	
R _{ON(peak)}	ON resistance (peak)	$V_I = GND$ to V_{CC} ; $I_{SW} = 100$ mA; see <u>Figure 7</u>						
		$V_{CC} = 1.4 V$	-	1.8	3.8	-	4.2	Ω
		V _{CC} = 1.65 V	-	1.0	1.7	-	1.8	Ω
		$V_{CC} = 2.3 V$	-	0.6	0.9	-	1.0	Ω
		$V_{CC} = 2.7 V$	-	0.6	0.80	-	1.0	Ω
		$V_{CC} = 4.3 V$	-	0.5	0.80	-	1.0	Ω
ΔR_{ON}	ON resistance mismatch	$V_I = GND \text{ to } V_{CC};$ $I_{SW} = 100 \text{ mA}$	<u>3]</u>					
	between channels	V_{CC} = 1.4 V; V_{SW} = 0.4 V	-	0.23	0.38	-	0.38	Ω
	Channels	V_{CC} = 1.65 V; V_{SW} = 0.5 V	-	0.23	0.28	-	0.38	Ω
		V_{CC} = 2.3 V; V_{SW} = 0.7 V	-	0.12	0.15	-	0.18	Ω
		$V_{CC} = 2.7 \text{ V}; V_{SW} = 0.8 \text{ V}$	-	0.12	0.15	-	0.18	Ω
		V_{CC} = 4.3 V; V_{SW} = 0.8 V	-	0.12	0.15	-	0.18	Ω
R _{ON(flat)}	ON resistance (flatness)	$V_{I} = GND \text{ to } V_{CC};$ $I_{SW} = 100 \text{ mA}$	4]					
		$V_{CC} = 1.4 V$	-	1.0	3.3	-	3.6	Ω
		V _{CC} = 1.65 V	-	0.5	1.2	-	1.3	Ω
		$V_{CC} = 2.3 V$	-	0.15	0.3	-	0.35	Ω
		$V_{CC} = 2.7 V$	-	0.13	0.3	-	0.35	Ω
		$V_{CC} = 4.3 V$	-	0.2	0.4	-	0.45	Ω

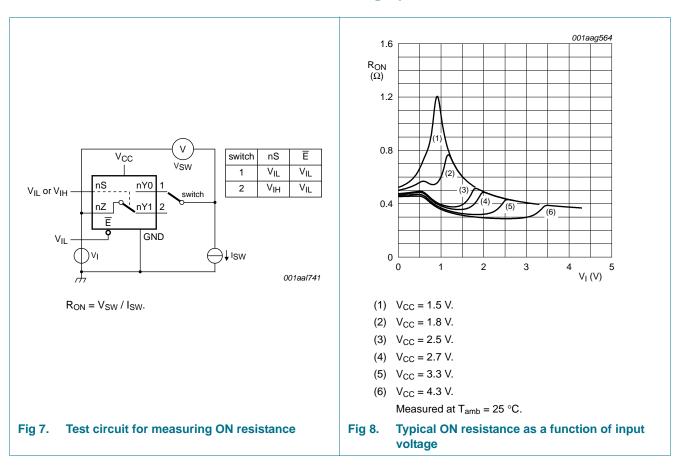
[1] For NX3L4053PW (TSSOP16 package), all ON resistance values are up to 0.05 Ω higher.

[2] Typical values are measured at $T_{amb} = 25 \ ^{\circ}C$.

[3] Measured at identical V_{CC}, temperature and input voltage.

[4] Flatness is defined as the difference between the maximum and minimum value of ON resistance measured at identical V_{CC} and temperature.

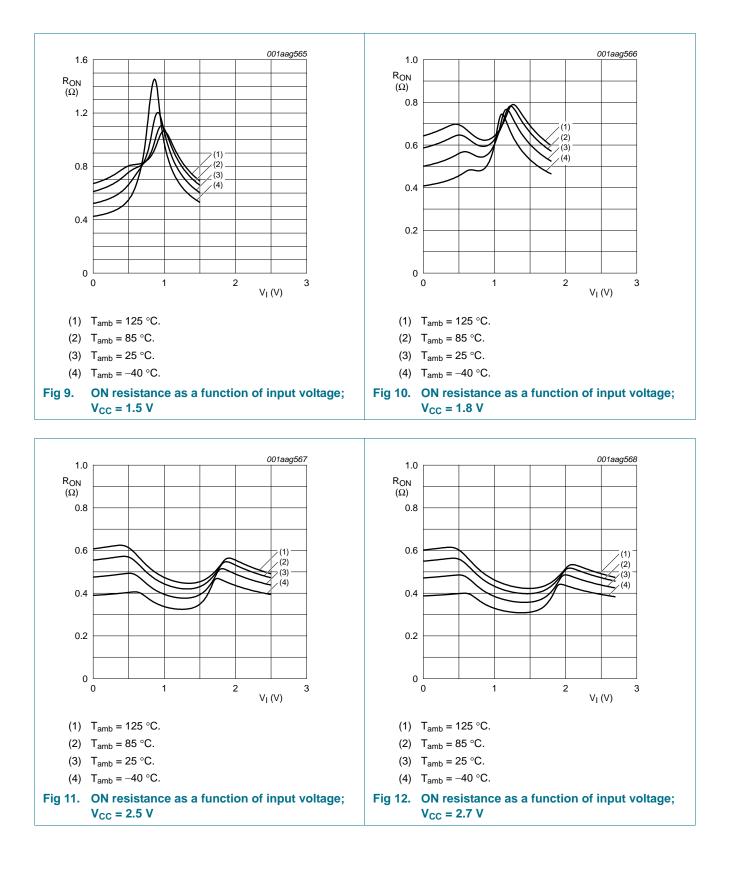
Triple low-ohmic single-pole double-throw analog switch



11.3 ON resistance test circuit and graphs

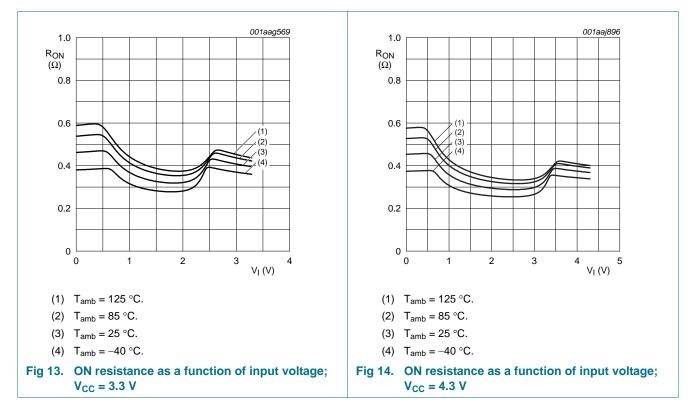
NX3L4053

Triple low-ohmic single-pole double-throw analog switch



NX3L4053

Triple low-ohmic single-pole double-throw analog switch



12. Dynamic characteristics

Table 9. Dynamic characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for load circuit see Figure 17.

Symbol	Parameter	Conditions	Ta	_{mb} = 25	°C	T _{amb} =	–40 °C to	+125 °C	Unit
			Min	Typ <mark>[1]</mark>	Мах	Min	Мах (85 °С)	Max (125 °C)	
t _{en}	enable time	Ē, nS to nZ or nYn; see <u>Figure 15</u>							
		V_{CC} = 1.4 V to 1.6 V	-	49	90	-	120	120	ns
		V _{CC} = 1.65 V to 1.95 V	-	35	70	-	80	90	ns
		V_{CC} = 2.3 V to 2.7 V	-	23	45	-	50	55	ns
		V_{CC} = 2.7 V to 3.6 V	-	21	40	-	45	50	ns
		V_{CC} = 3.6 V to 4.3 V	-	21	40	-	45	50	ns
t _{dis}	disable time	Ē, nS to nZ or nYn; see <u>Figure 15</u>							
		V_{CC} = 1.4 V to 1.6 V	-	32	70	-	80	90	ns
		V_{CC} = 1.65 V to 1.95 V	-	17	55	-	60	65	ns
		V_{CC} = 2.3 V to 2.7 V	-	11	25	-	30	35	ns
		V_{CC} = 2.7 V to 3.6 V	-	8	20	-	25	30	ns
		V_{CC} = 3.6 V to 4.3 V	-	8	20	-	25	30	ns

Triple low-ohmic single-pole double-throw analog switch

Symbol	Parameter	Conditions		Ta	_{mb} = 25	°C	T _{amb} =	–40 °C to	+125 °C	Unit
				Min	Typ <mark>[1]</mark>	Max	Min	Max (85 °C)	Max (125 °C)	
t _{b-m}	break-before-make	see Figure 16	[2]					•		
	time	$V_{CC} = 1.4 \text{ V}$ to 1.6 V		-	19	-	9	-	-	ns
		$V_{CC} = 1.65 \text{ V} \text{ to } 1.95 \text{ V}$		-	17	-	7	-	-	ns
		V_{CC} = 2.3 V to 2.7 V		-	13	-	4	-	-	ns
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$		-	10	-	3	-	-	ns
		V_{CC} = 3.6 V to 4.3 V		-	9	-	2	-	-	ns

Table 9. Dynamic characteristics ... continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for load circuit see Figure 17.

[1] Typical values are measured at T_{amb} = 25 °C and V_{CC} = 1.5 V, 1.8 V, 2.5 V, 3.3 V and 4.3 V respectively.

[2] Break-before-make guaranteed by design.

12.1 Waveform and test circuits

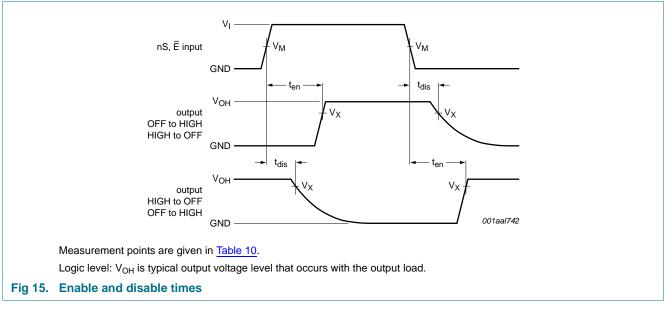
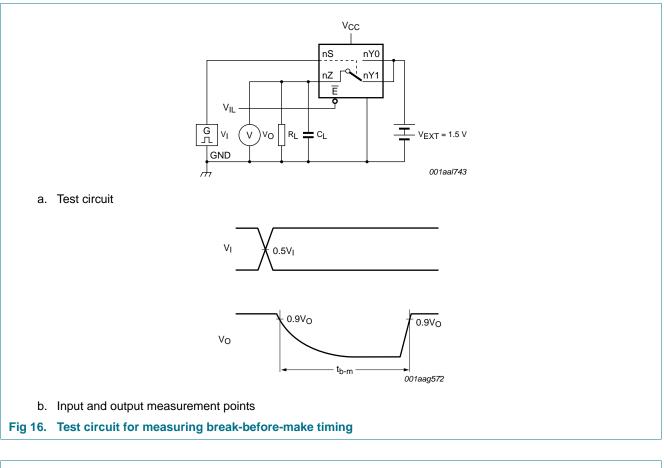


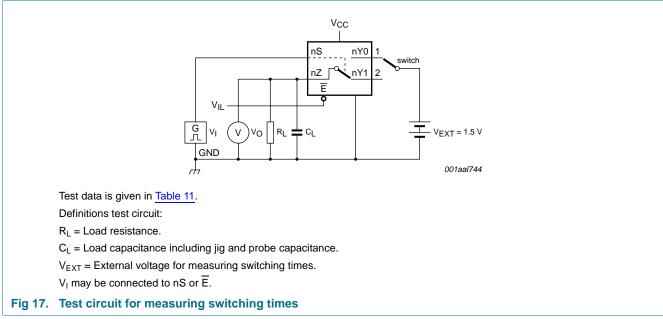
Table 10. Measurement points

Supply voltage	Input	Output
V _{cc}	V _M	V _X
1.4 V to 4.3 V	0.5V _{CC}	0.9V _{OH}

NX3L4053

Triple low-ohmic single-pole double-throw analog switch





Triple low-ohmic single-pole double-throw analog switch

Table 11.Test data

Supply voltage	Input		Load	
V _{cc}	VI	t _r , t _f	CL	R _L
1.4 V to 4.3 V	V _{CC}	≤ 2.5 ns	35 pF	50 Ω

12.2 Additional dynamic characteristics

Table 12. Additional dynamic characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); $V_I = GND$ or V_{CC} (unless otherwise specified); $t_r = t_f \le 2.5$ ns; $T_{amb} = 25$ °C.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
THD	total harmonic distortion	$f_i = 20 \text{ Hz to } 20 \text{ kHz}; \text{ R}_L = 32 \Omega; \text{ see } \frac{\text{Figure } 18}{1000 \text{ sec } 18}$	<u>[1]</u>			
		V _{CC} = 1.4 V; V _I = 1 V (p-p)	-	0.15	-	%
		V _{CC} = 1.65 V; V _I = 1.2 V (p-p)	-	0.10	-	%
		V _{CC} = 2.3 V; V _I = 1.5 V (p-p)	-	0.02	-	%
		V _{CC} = 2.7 V; V _I = 2 V (p-p)	-	0.02	-	%
		$V_{CC} = 4.3 \text{ V}; \text{ V}_{I} = 2 \text{ V} (p-p)$	-	0.02	-	%
f _(-3dB)	-3 dB frequency	$R_L = 50 \Omega$; see Figure 19	<u>[1]</u>			
()	response	$V_{CC} = 1.4 \text{ V to } 4.3 \text{ V}$	-	60	-	MHz
α_{iso}	isolation (OFF-state)	$f_i = 100 \text{ kHz}; R_L = 50 \Omega; \text{ see } \frac{\text{Figure 20}}{100 \text{ kHz}}$	<u>[1]</u>			
		$V_{CC} = 1.4 \text{ V to } 4.3 \text{ V}$	-	-90	-	dB
V _{ct}	crosstalk voltage	between digital inputs and switch; $f_i = 1 \text{ MHz}$; $C_L = 50 \text{ pF}$; $R_L = 50 \Omega$; see Figure 21				
		$V_{CC} = 1.4 \text{ V to } 3.6 \text{ V}$	-	0.2	-	V
		$V_{CC} = 3.6 \text{ V to } 4.3 \text{ V}$	-	0.3	-	V
Xtalk	crosstalk	between switches; $f_i = 100 \text{ kHz}$; $R_L = 50 \Omega$; see Figure 22	<u>[1]</u>			
		$V_{CC} = 1.4 \text{ V to } 4.3 \text{ V}$	-	-90	-	dB
Q _{inj}	charge injection	$f_i = 1 \text{ MHz}; C_L = 0.1 \text{ nF}; R_L = 1 \text{ M}\Omega; V_{gen} = 0 \text{ V}; R_{gen} = 0 \Omega; \text{ see } \frac{\text{Figure 23}}{2}$				
		V _{CC} = 1.5 V	-	3	-	рС
		V _{CC} = 1.8 V	-	4	-	рС
		$V_{CC} = 2.5 V$	-	6	-	рС
		$V_{CC} = 3.3 V$	-	9	-	рС
		$V_{CC} = 4.3 V$	-	15	-	рС

[1] f_i is biased at 0.5V_{CC}.

Triple low-ohmic single-pole double-throw analog switch

12.3 Test circuits

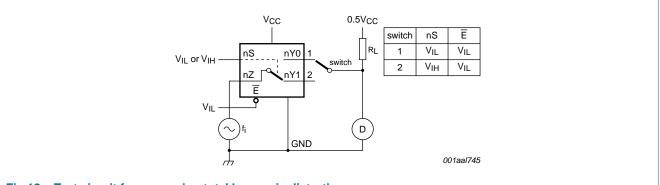
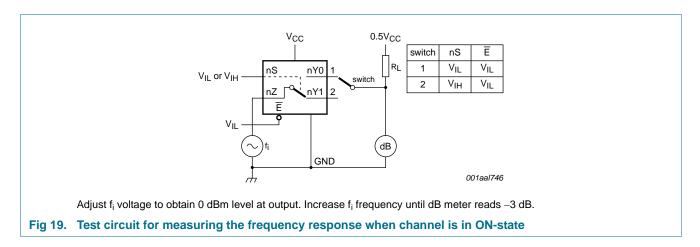
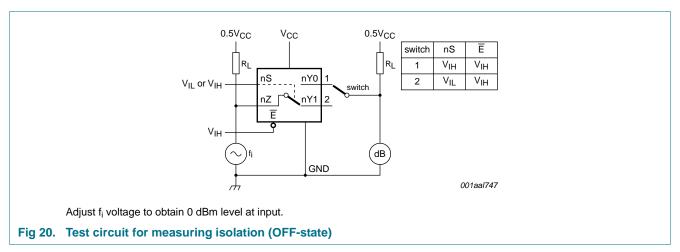
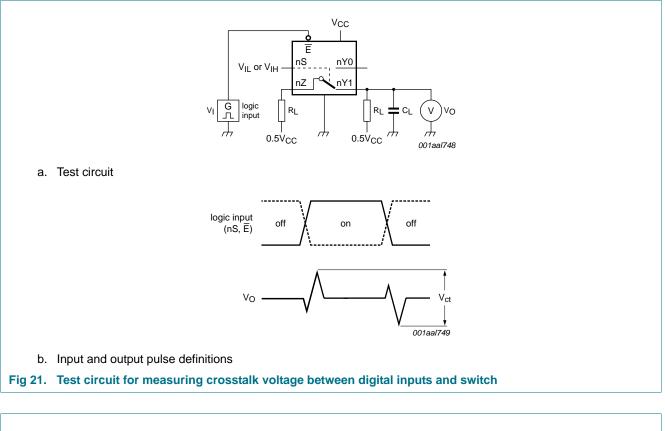


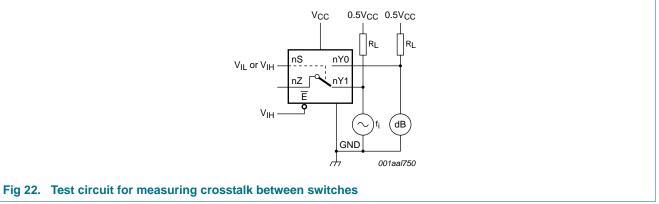
Fig 18. Test circuit for measuring total harmonic distortion





Triple low-ohmic single-pole double-throw analog switch

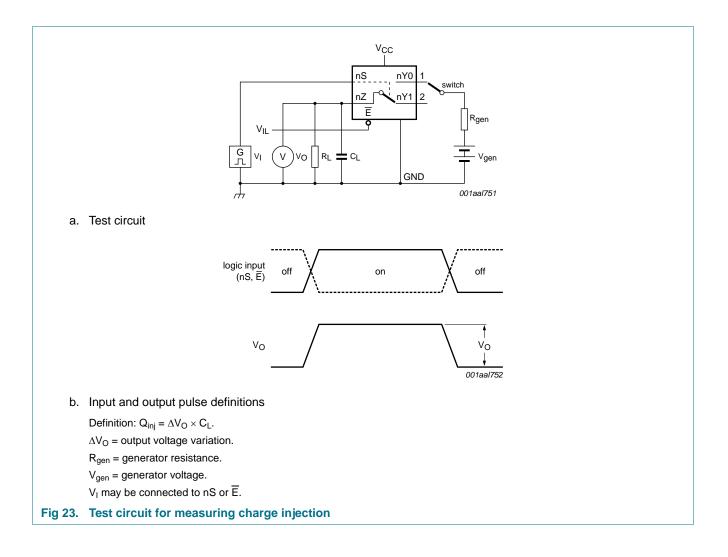




15 of 22

NX3L4053

Triple low-ohmic single-pole double-throw analog switch



NX3L4053

Triple low-ohmic single-pole double-throw analog switch

13. Package outline

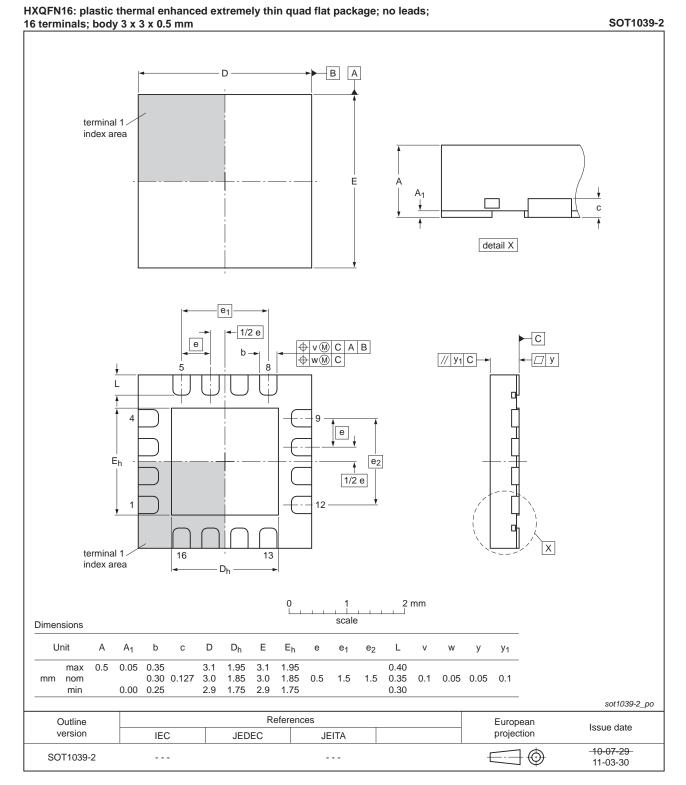


Fig 24. Package outline SOT1039-2 (HXQFN16)

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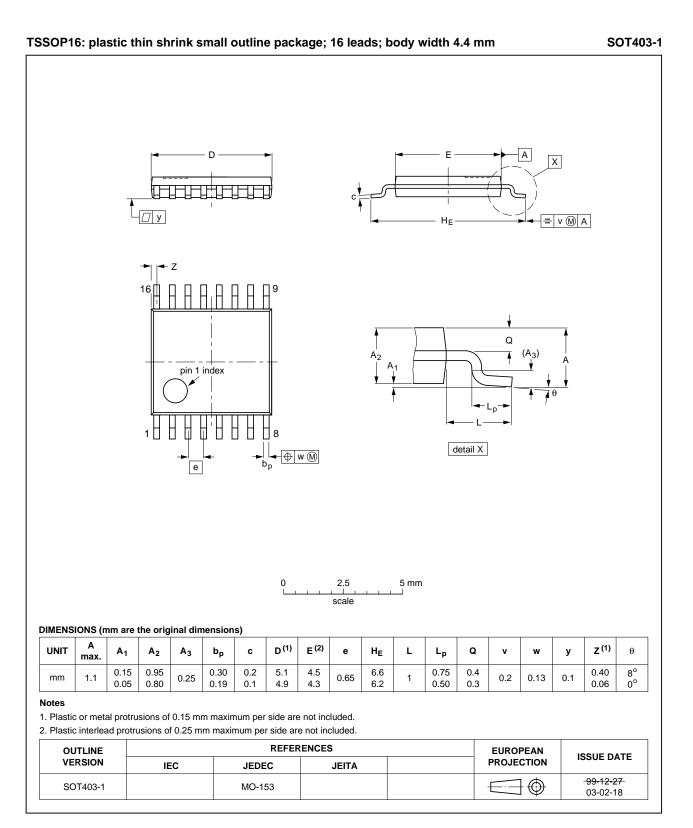


Fig 25. Package outline SOT403-1 (TSSOP16)

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Triple low-ohmic single-pole double-throw analog switch

14. Abbreviations

Table 13. Abbreviations				
Acronym	Description			
CDM	Charged Device Model			
CMOS	Complementary Metal-Oxide Semiconductor			
ESD	ElectroStatic Discharge			
HBM	Human Body Model			
MM	Machine Model			
PDA	Personal Digital Assistant			

15. Revision history

Table 14. Revision	n history			
Document ID	Release date	Data sheet status	Change notice	Supersedes
NX3L4053 v.5	20120625	Product data sheet	-	NX3L4053 v.4
Modifications:	 For type nu 	mber NX3L4053HR the sot	code has changed to S	OT1039-2.
NX3L4053 v.4	20111107	Product data sheet	-	NX3L4053 v.3
Modifications:	 Legal page 	s updated.		
NX3L4053 v.3	20101223	Product data sheet	-	NX3L4053 v.2
NX3L4053 v.2	20100811	Product data sheet	-	NX3L4053 v.1
NX3L4053 v.1	20100416	Product data sheet	-	-

16. Legal information

16.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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Triple low-ohmic single-pole double-throw analog switch

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21 of 22

NX3L4053

Triple low-ohmic single-pole double-throw analog switch

18. Contents

1	General description	. 1
2	Features and benefits	. 1
3	Applications	. 2
4	Ordering information	. 2
5	Marking	. 2
6	Functional diagram	. 3
7	Pinning information	. 3
7.1	Pinning	. 3
7.2	Pin description	. 4
8	Functional description	. 4
9	Limiting values	. 4
10	Recommended operating conditions	. 5
11	Static characteristics	. 5
11.1	Test circuits	. 6
11.2	ON resistance	
11.3	ON resistance test circuit and graphs	. 8
12	Dynamic characteristics	10
12.1	Waveform and test circuits	
12.2	Additional dynamic characteristics	
12.3	Test circuits	14
13	Package outline	. 17
14	Abbreviations	. 19
15	Revision history	. 19
16	Legal information	20
16.1	Data sheet status	20
16.2	Definitions	
16.3	Disclaimers	20
16.4	Trademarks	21
17	Contact information	21
18	Contents	22

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